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(12) **United States Design Patent**
Williams et al.

(10) **Patent No.:** **US D593,075 S**

(45) **Date of Patent:** **** May 26, 2009**

(54) **EARHOOK AND EARBUD HEADSET**

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(**) Term: **14 Years**

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(22) Filed: **May 13, 2008**

(51) **LOC (9) Cl.** **14-01**

(52) **U.S. Cl.** **D14/223**

(58) **Field of Classification Search** D14/205,
D14/206, 223, 188, 192, 142, 240; 181/129,
181/130; 381/380, 381, 385, 370, 374, 376,
381/377, 378, 379, 330; 379/430; 455/575.1,
455/575.2, 569.1

See application file for complete search history.

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(57) **CLAIM**

What is claimed is the ornamental design for an earhook and earbud headset, as shown and described.

DESCRIPTION

FIG. 1 is an outside elevation view of one embodiment of the headset of our new design with the input wire to the earbud broken away;

FIG. 2 is a top view thereof;

FIG. 3 is a bottom view thereof;

FIG. 4 is a rear elevation view thereof;

FIG. 5 is a front elevation view thereof;

FIG. 6 is an inside elevation view thereof;

FIG. 7 is a perspective view thereof;

FIG. 8 is an outside elevation view of a second embodiment of the headset of our new design with the input wire to the earbud broken away;

FIG. 9 is a top view thereof;

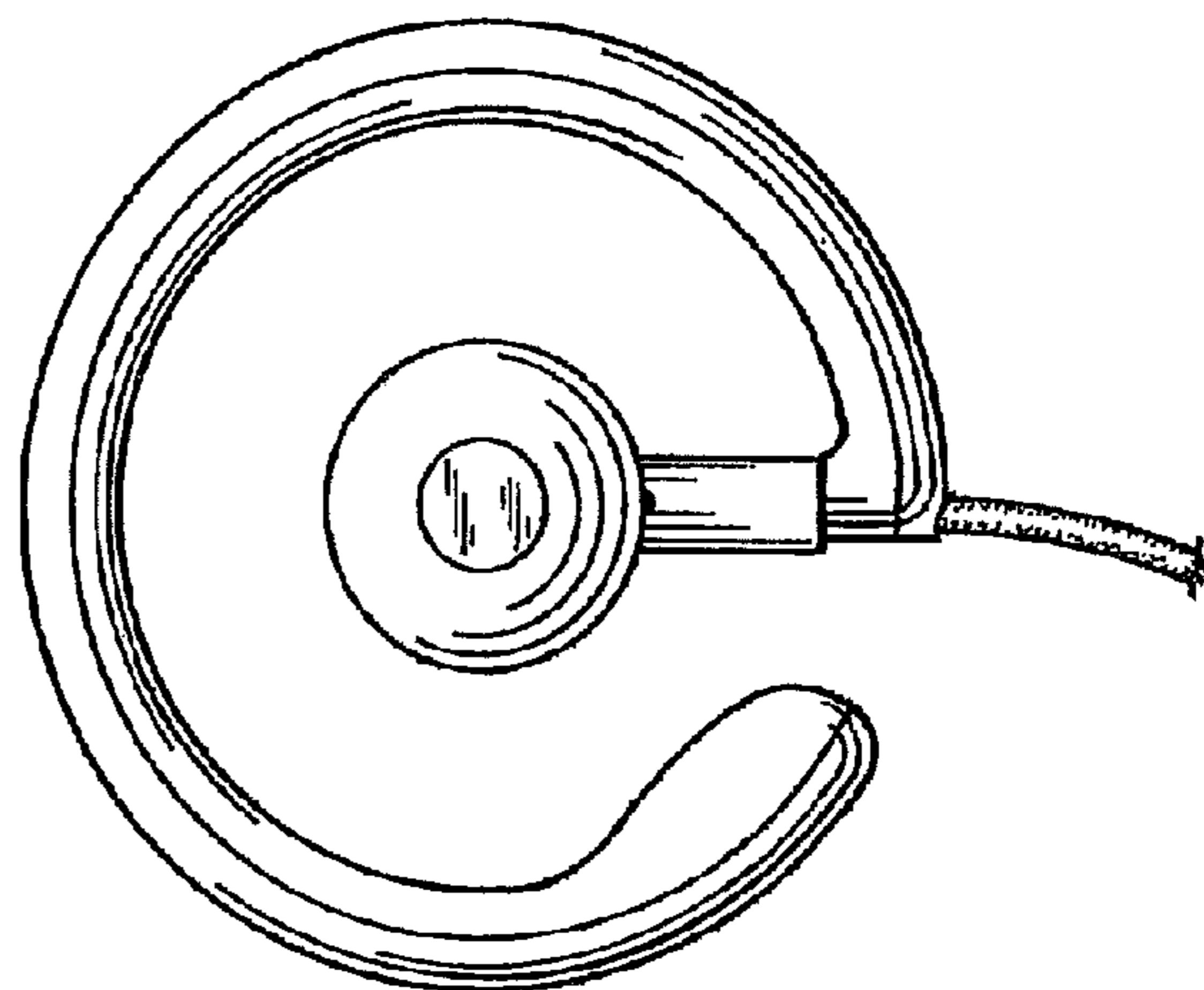
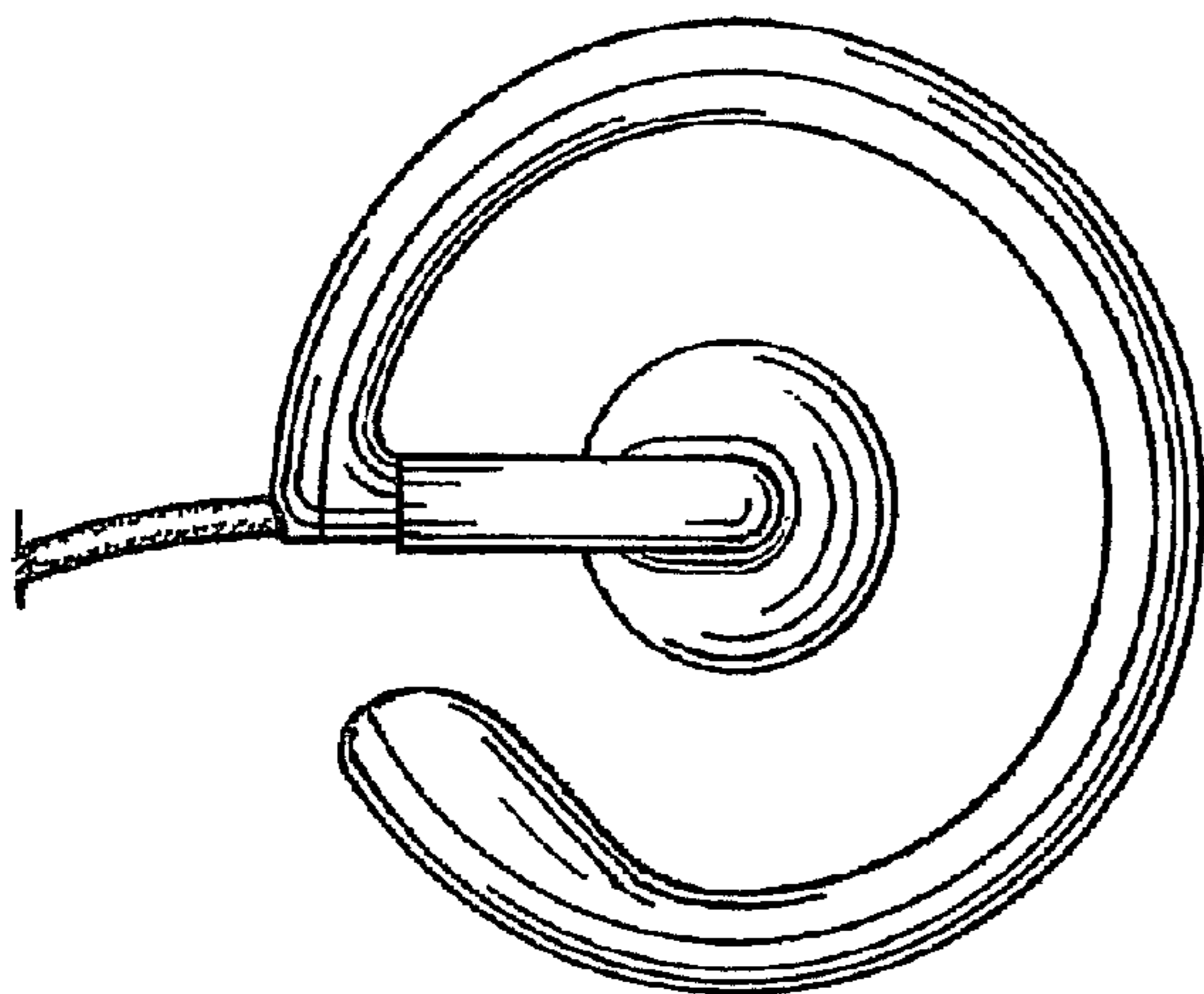
FIG. 10 is a bottom view thereof;

FIG. 11 is a front elevation view thereof;

FIG. 12 is a rear elevation view thereof; and,

FIG. 13 is an inside elevation view thereof.

1 Claim, 5 Drawing Sheets



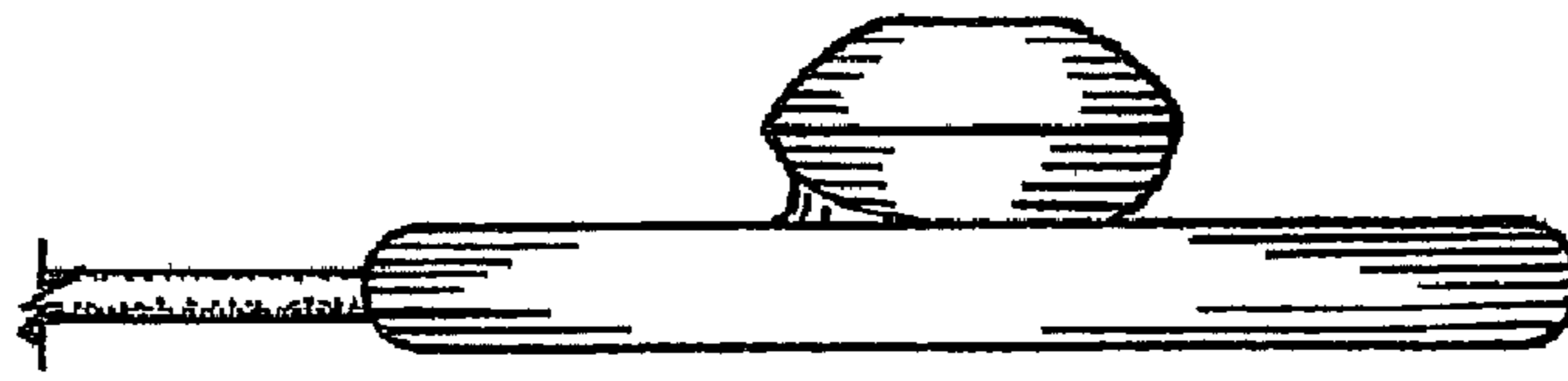


FIG. 2

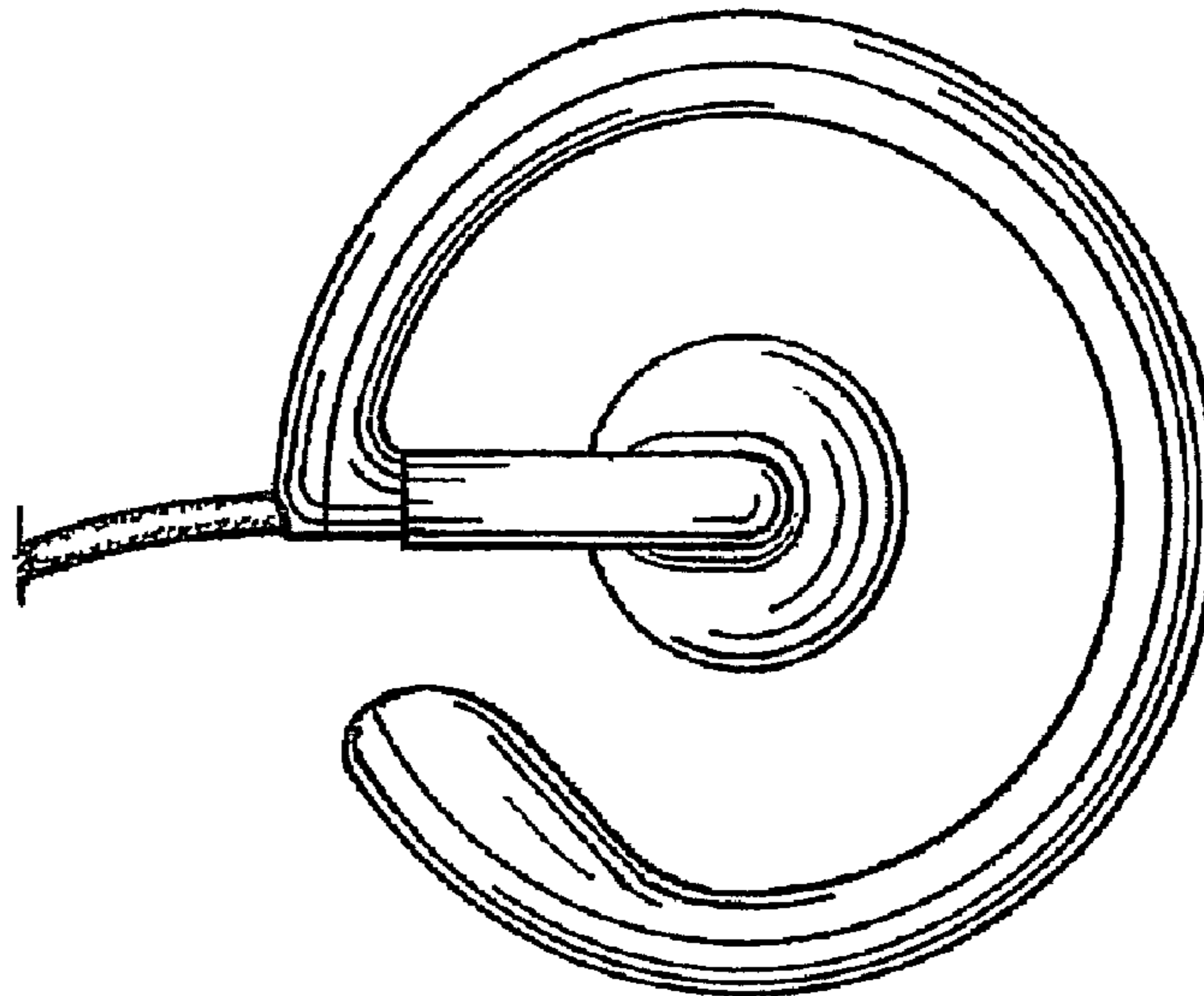


FIG. 1

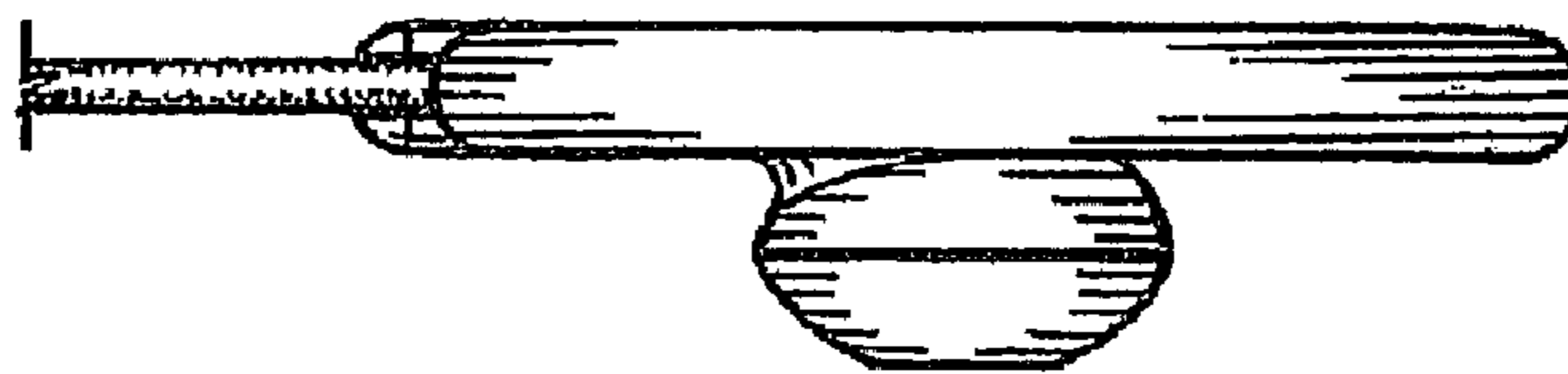


FIG. 3



FIG. 4

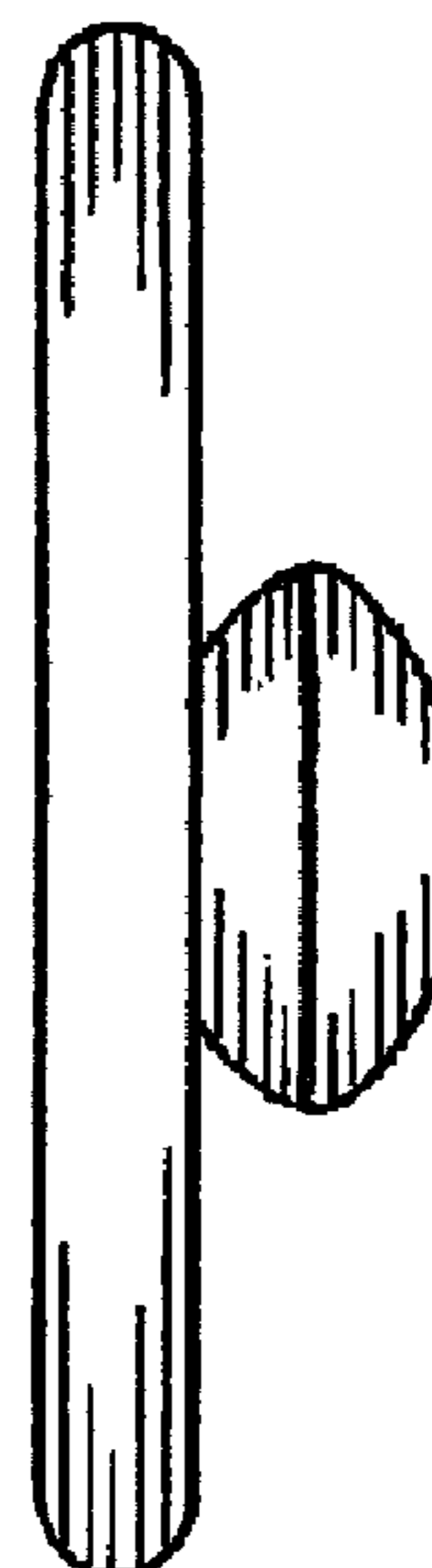


FIG. 5

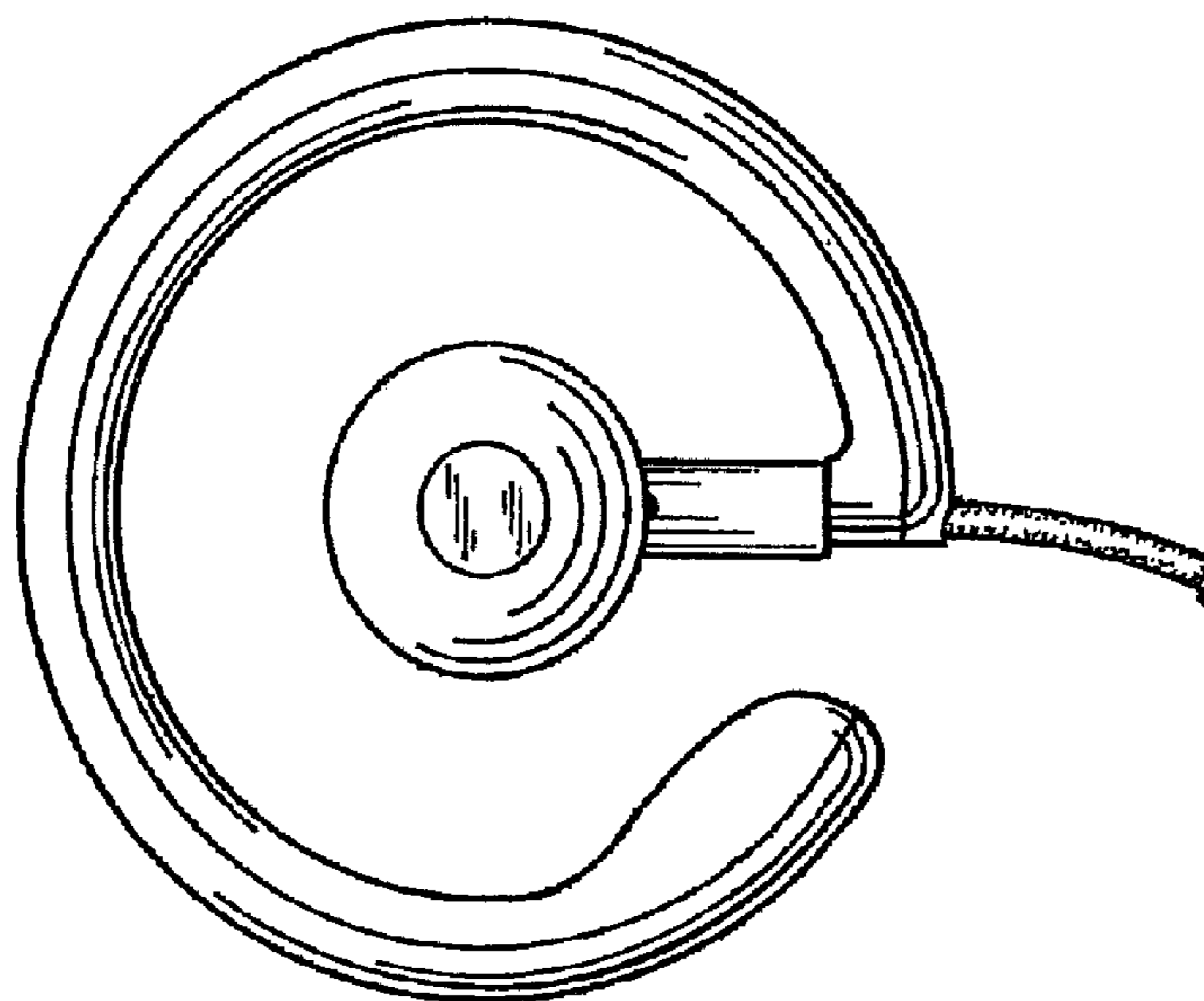


FIG. 6

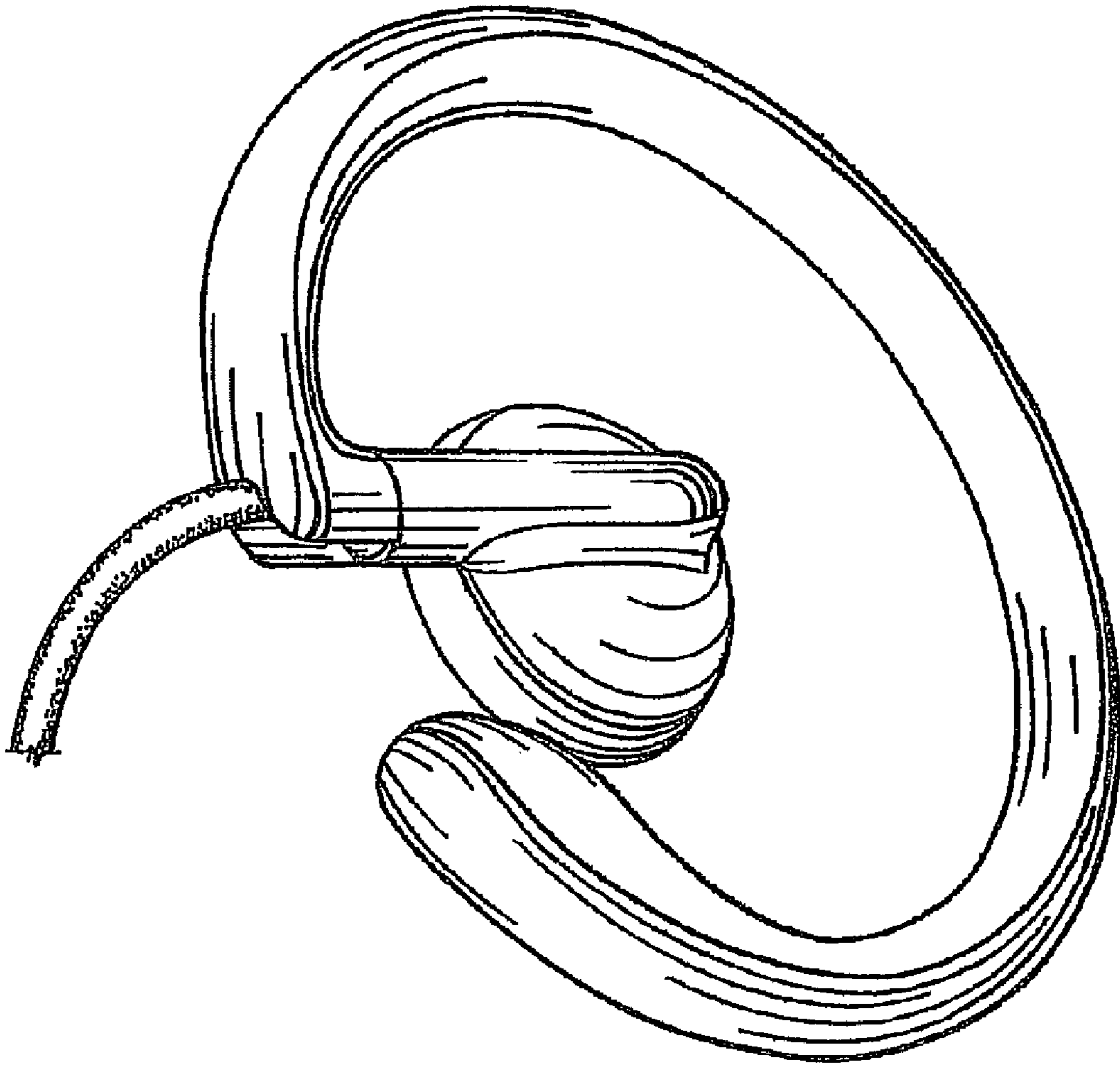


FIG. 7

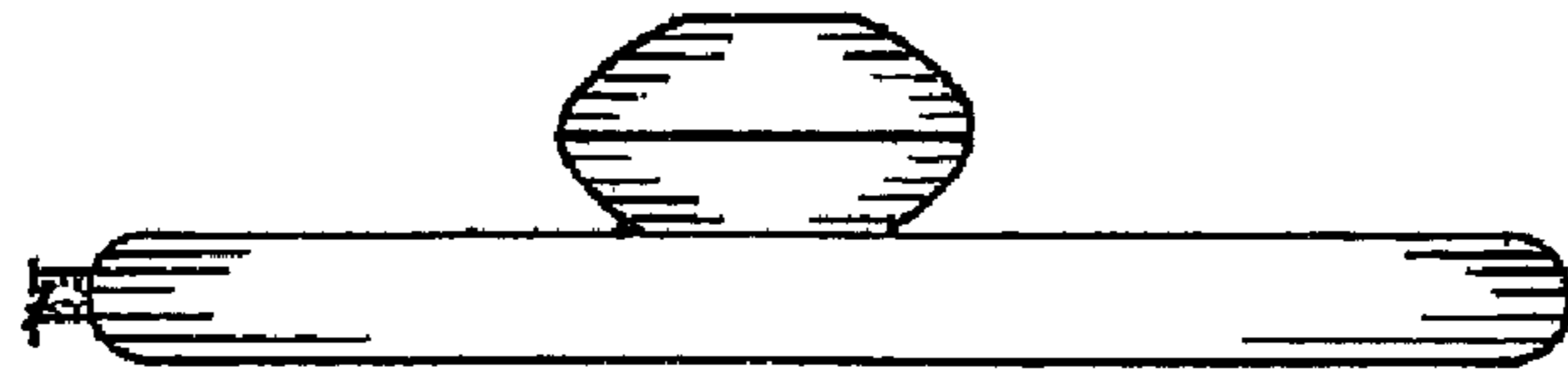


FIG. 9

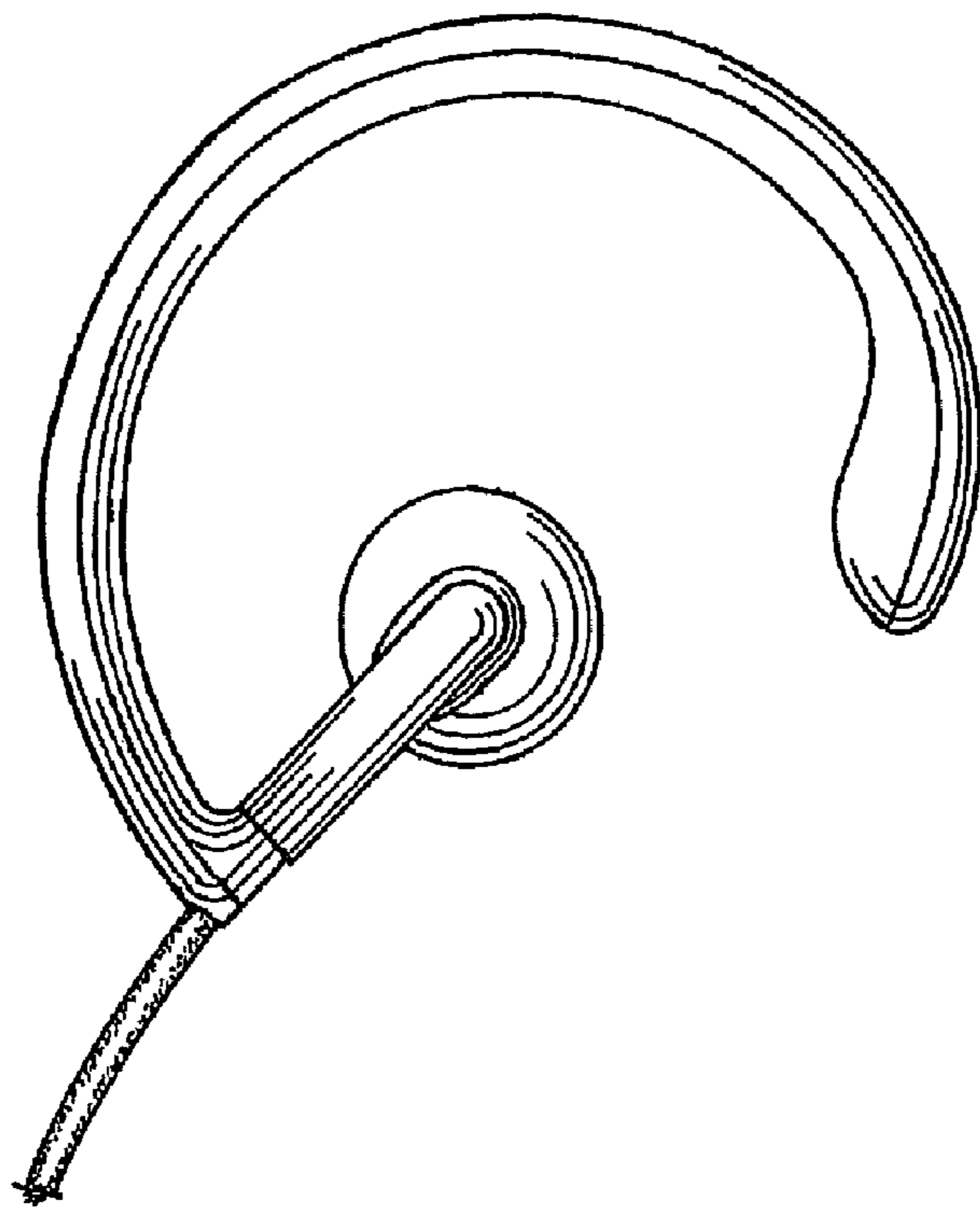


FIG. 8

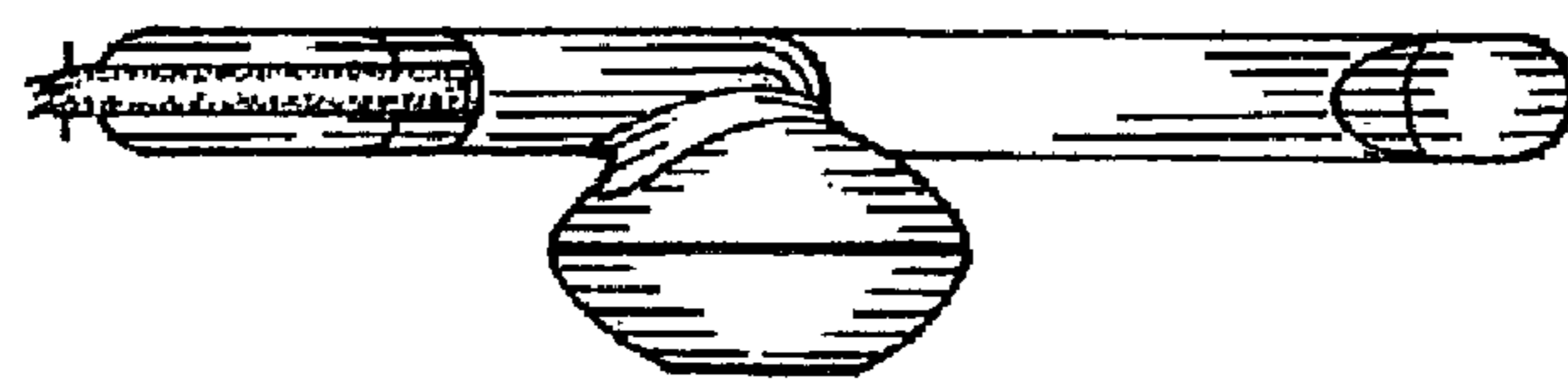


FIG. 10



FIG. 11



FIG. 12

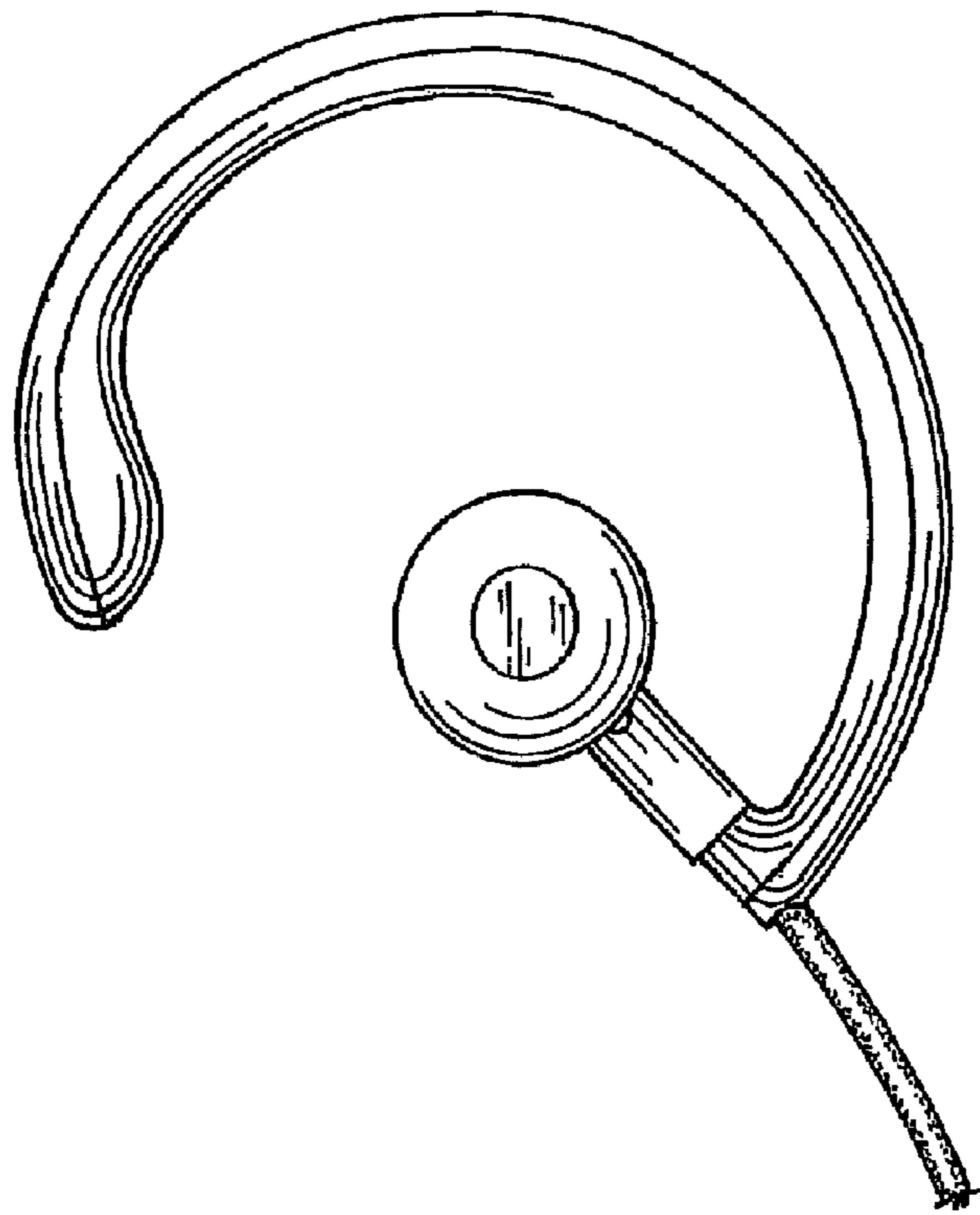


FIG. 13